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November 2013

FGL35N120FTD 1200 V, 35 A Field Stop Trench IGBT

Features

- Field Stop Trench Technology
- · High Speed Switching
- Low Saturation Voltage: V_{CE(sat)} = 1.68 V @ I_C = 35 A
- High Input Impedance

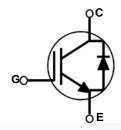
Applications

• Solar Inverter, UPS, Welder, PFC

General Description

Using advanced field stop trench IGBT technology, Fairchild's 1200V trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder appli-





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		1200	V
V_{GES}	Gate to Emitter Voltage		± 25	V
	Collector Current	@ T _C = 25°C	70	A
l _C	Collector Current	$@ T_C = 100^{\circ}C$	35	A
I _{CM (1)}	Pulsed Collector Current @ T _C = 25°C 105		105	A
	Diode Continuous Forward Current	@ T _C = 25°C	80	A
I _F	Diode Continuous Forward Current	$@ T_C = 100^{\circ}C$	40	A
P_{D}	Maximum Power Dissipation	@ T _C = 25°C	368	W
' Б	Maximum Power Dissipation	$@ T_C = 100^{\circ}C$	147	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes:
1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Max.	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	0.34	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	0.9	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	25	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGL35N120FTDTU	FGL35N120FTD	TO-264	Tube	N/A	N/A	30

Electrical Characteristics of the IGBT $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu A$	1200	-	-	V
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	1	mA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±250	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I_C = 35 mA, V_{CE} = V_{GE}	3.5	6.2	7.5	V
		I _C = 35 A, V _{GE} = 15 V	-	1.68	2.2	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 35 A, V _{GE} = 15 V, T _C = 125°C	-	2.0	-	V
Dynamic C	haracteristics			1		
C _{ies}	Input Capacitance		-	5090	-	pF
C _{oes}	Output Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V},$ f = 1 MHz	-	180	-	pF
C _{res}	Reverse Transfer Capacitance	1 = 1 WITZ	-	95	-	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{CC} = 600 V, I _C = 35 A,	-	34	-	ns
t _r	Rise Time		-	63	-	ns
t _{d(off)}	Turn-Off Delay Time		-	172	-	ns
t _f	Fall Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$,	-	107	-	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C	-	2.5	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.7	-	mJ
E _{ts}	Total Switching Loss		-	4.2	-	mJ
t _{d(on)}	Turn-On Delay Time		- /	33	-	ns
t _r	Rise Time		-	66	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 600 \text{ V}, I_{C} = 35 \text{ A},$	_	180	-	ns
t _f	Fall Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$,	-	146	-	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C	-	3.1	-	mJ
E _{off}	Turn-Off Switching Loss		-	2.1	-	mJ
E _{ts}	Total Switching Loss		-	5.2	- //	mJ
Q _g	Total Gate Charge		-	210	-	nC
Q _{ge}	Gate to Emitter Charge	$V_{CE} = 600 \text{ V}, I_{C} = 35 \text{ A},$ $V_{GF} = 15 \text{ V}$	-	42	- \	nC
Q _{gc}	Gate to Collector Charge	VGE - 13 V	-	101	-	nC

Electrical Characteristics of the Diode $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I IF = 35 A	$T_C = 25^{\circ}C$	-	2.7	3.4	V
- FIVI			$T_{\rm C} = 125^{\rm o}{\rm C}$	ı	2.5	-	
t _{rr}	Diode Reverse Recovery Time	I _F = 35 A, di _F /dt = 200 A/μs	$T_C = 25^{\circ}C$	-	337	-	ns
111	Tr 2.000 November 1.000 November 2.000		$T_{\rm C} = 125^{\rm o}{\rm C}$	-	520	-	
Irr	Diode Peak Reverse Recovery Current		$T_C = 25^{\circ}C$	-	7.6	-	Α
1.11			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	12.9	-	, ,
Q	Q _{rr} Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1292	-	nC
2.000			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	3377	-	

Figure 1. Typical Output Characteristics

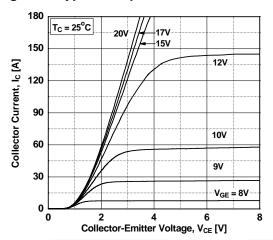


Figure 3. Typical Saturation Voltage Characteristics

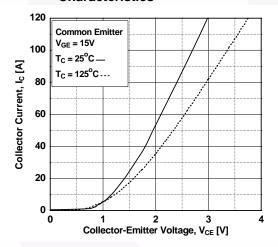


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level

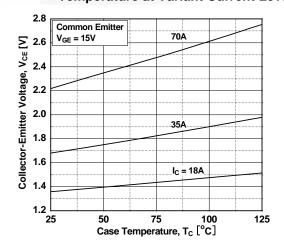


Figure 2. Typical Output Characteristics

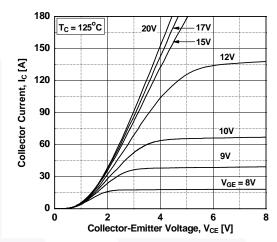


Figure 4. Transfer Characteristics

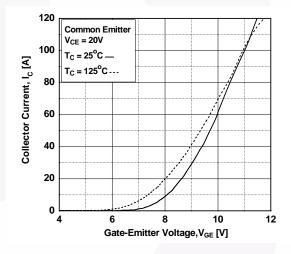


Figure 6. Saturation Voltage vs. V_{GE}

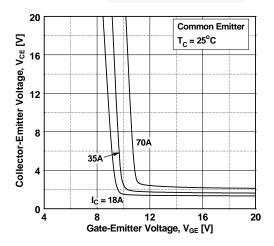


Figure 7. Saturation Voltage vs. V_{GE}

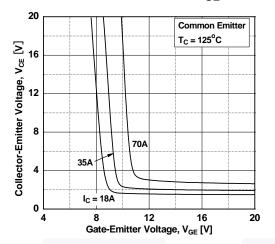


Figure 9. Capacitance Characteristics

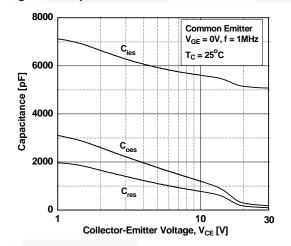


Figure 11. SOA Characteristics

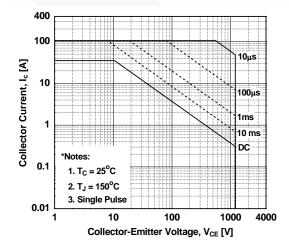


Figure 8. Load Current vs. Frequency

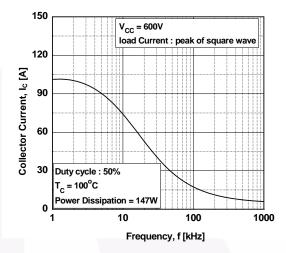


Figure 10. Gate Charge Characteristics

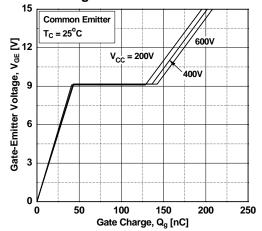


Figure 12. Turn-on Characteristics vs.
Gate Resistance

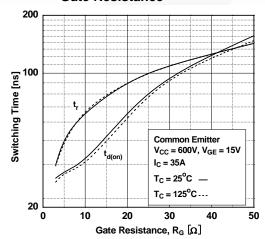


Figure 13. Turn-off Characteristics vs.
Gate Resistance

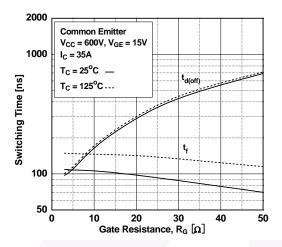


Figure 15. Turn-off Characteristics vs. Collector Current

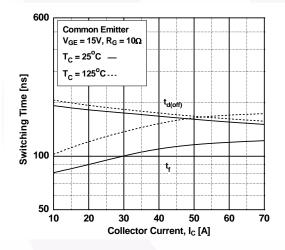


Figure 17. Switching Loss vs. Collector Current

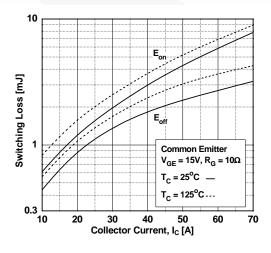


Figure 14. Turn-on Characteristics vs. Collector Current

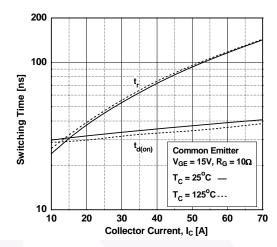


Figure 16.Switching Loss vs. Gate Resistance

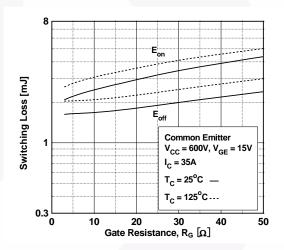


Figure 18. Turn off Switching SOA Characteristics

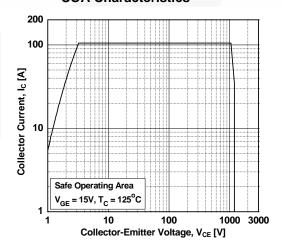


Figure 19. Forward Characteristics

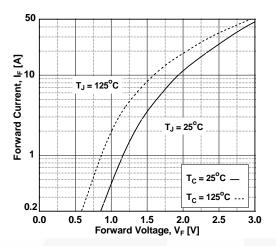


Figure 20. Reverse Recovery Current

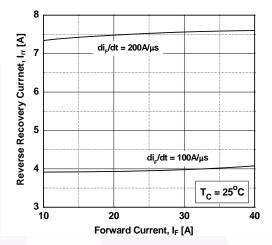


Figure 21. Stored Charge

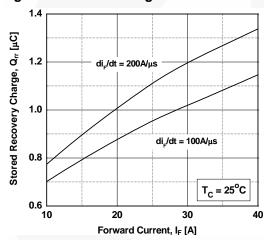


Figure 22. Reverse Recovery Time

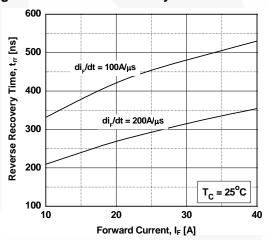
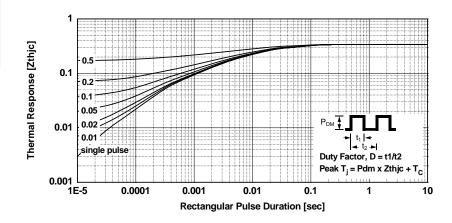
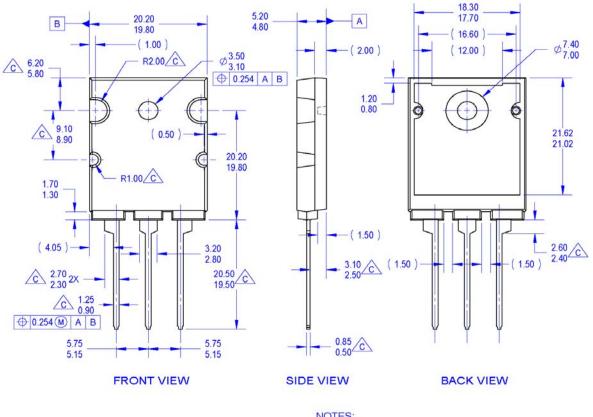
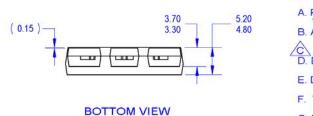


Figure 23.Transient Thermal Impedance of IGBT



Mechanical Dimensions





NOTES:

- A. PACKAGE REFERENCE: JEDEC TO264 VARIATION AA. B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE.
 DIMENSION AND TOLERANCE AS PER ASME
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- P14.5-1994.

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- G. DRAWING FILE NAME: TO264A03REV1

Figure 24. TO-264 3L - 3LD; TO264; MOLDED; JEDEC VARIATION AA

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